
Economical and High-Quality PLC
FATEK B1/B1z Series Micro-Programmable Controllers



Features

■ Core Technology of Advanced SoC

With advanced software and hardware technique and over 20 years of experience in automation industry, FATEK has integrated the entire PLC system with self-developed CPU, hardware logic solver (HLS), hardware high-speed counter/timer, NC positioning, communication, FLASH, and SRAM, into a tiny BGA chip. This is the first attempt of PLC industry that makes FATEK a leading brand in micro PLC.

■ Compact and Rugged

As most parts of the system are integrated into a SoC, the processor and I/O section can be manufactured in a single PCB board and thus substantially reduced the dimension. Since a single board does not need any board-to-board connector, the overall structure becomes more stable and reliable.

■ High Quality and High Reliability

As the excellent streamline of hardware design and highly integrated of SoC technology, it minimizes the number of constituent parts of B1/B1z series of PLC. And with the combination of high quality parts and rigorous quality control procedures, FATEK creates a high quality and high reliability PLC for the industry.

■ Competitive Low Price

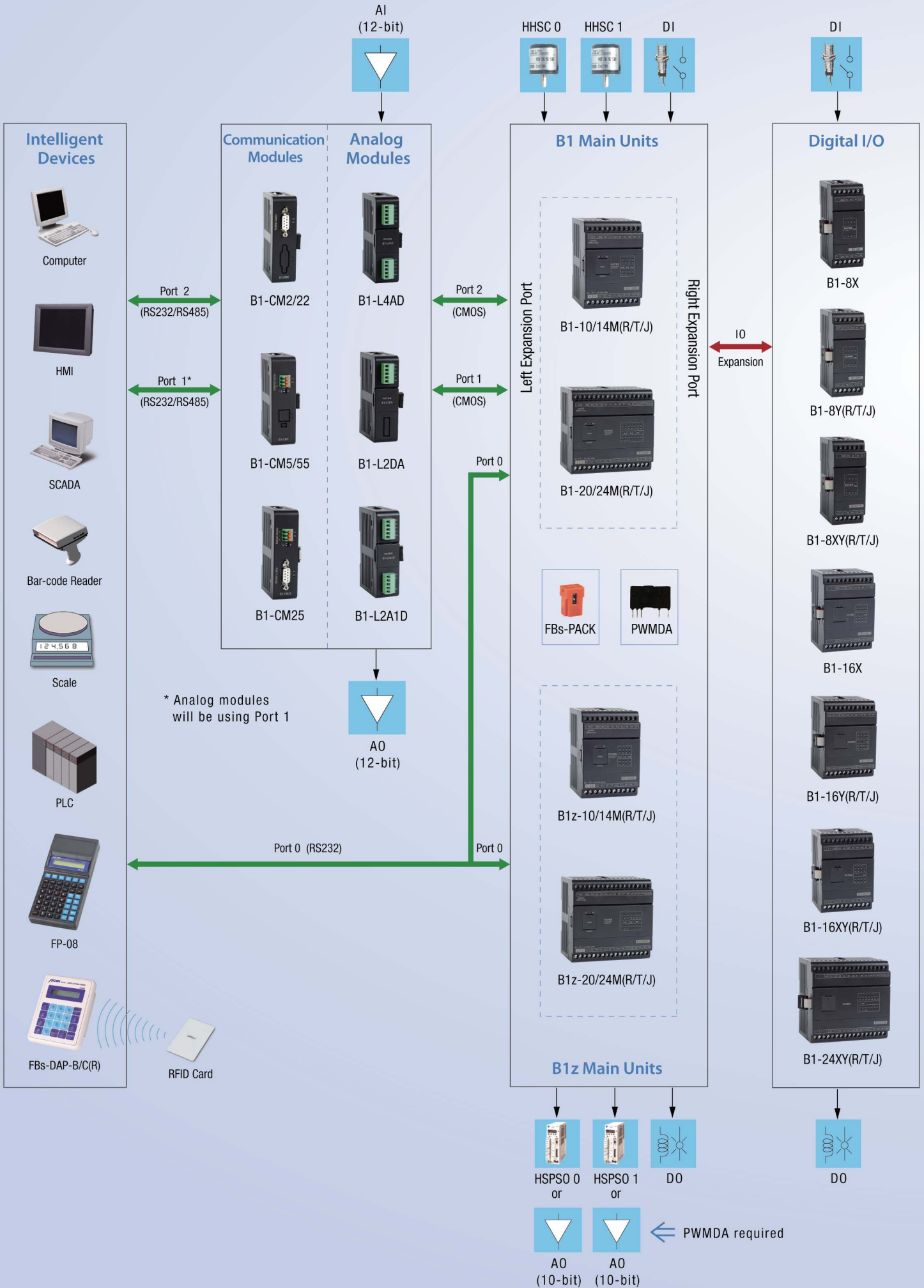
Besides the streamline design of SoC technology that significantly reduces the hardware costs, B1/B1z series PLC incorporates the most sophisticated manufacturing process and most mature and stable quality of two-layer board design. With FATEK's many years of experience in EMC control, the capability of noise resistance of FATEK PLC using two-layer board design is better than four-layer board design of other PLC, thus making B1/B1z PLC a price-competitive must-buy for smart dealers.

■ Easy to use, consistent instruction

The instruction sets of B1/B1z series PLC is based on the FBs series PLC, which is the best-selling series of FATEK. Considering compatibility and simplicity, the instructions for B1/B1z series PLC are thoughtfully selected from the most useful and frequently used instructions of FBs series PLC.



System Configuration



General Specifications

Environmental specifications

Item		Specification		Note
Operating ambient temperature	Enclosure space	Minimum	5°C	Permanent installation
		Maximum	40°C	
	Open space	Minimum	5°C	
		Maximum	55°C	
Storage temperature		-25°C ~ +70°C		
Relative humidity (non-condensing, RH-2)		5% ~ 95%		
Pollution resistance		Degree II		
Corrosion resistance		Base on IEC-68 standard		
Altitude		≤2000m		
Vibration resistance	Fixed by DIN RAIL		0.5G, 2 hours for each direction of 3 axes	
	Fasten by screw		2G, 2 hours for each direction of 3 axes	
Shock resistance		10G, three times for each direction of 3 axes		
Noise resistance		1500 Vp-p, pulse width 1μS		
Withstand voltage		1500VAC, 1 minute		L, N to any terminal

AC power supply

Specification	Item	10 points main unit	14 points main unit	20 points main unit	24 points main unit
Input power	Voltage	85VAC~264VAC			
	Frequency	50/60Hz ±5%			
Max. power consumption (built-in power supply)		21W			
Inrush current		20A@264VAC			
Allowable power momentary interruption time		< 20mS			
Fuse rating		2A, 250VAC			

DC power supply

Specification	Item	10 points main unit	14 points main unit	20 points main unit	24 points main unit
Input voltage		20.4VDC~28.8VDC			
Max. power consumption		2.5W	3.0W	3.5W	4.0W
Inrush current		20A@DC24V			
Allowable power momentary interruption time		< 2mS			
Fuse rating		1A, 125V			

Functional Specifications

Main unit specifications

Specification		Model	B1	B1z	
Execution speed		0.33uS/Contact instruction			
Memory capacity	Program capacity (Step)	7936	3840		
	Element comment capacity (Byte)	8K	4K		
Maximum I/O points	Input contact X (Point)	X+Y=64 *1	6/8/12/14		
	Output contact Y (Point) *4		4/6/8/10		
	Analog input (Point)	D4072~D4075 (4) *2	—		
	Analog output (Point)	D4076~D4077 (2) *2	—		
Internal relay (M)	Non-retentive (Point)	M0~M799 (800) M1400~M1911 (512)	M0~M511 (512)		
	Retentive (Point)	M800~M1399 (600)	M512~M767 (256)		
	Special relay (Point)	M1912~M2001 (90)	M1912~M2001 (90)		
Step relay (S)	Initial step (Point)	S0~S7 (8)	S0~S7 (8)		
	Non-retentive (Point)	S20~S499 (480)	S20~S143 (124)		
	Retentive (Point)	S500~S999 (500)	S144~S271 (128)		
Timer	1S	T200~T219 (20)	T200~T219 (20)		
	100mS	T50~T199 (150)	T50~T113 (64)		
	10mS	T0~T49 (50)	T0~T49 (50)		
	1mS	R4151 (1)	R4151 (1)		
	Accumulative	FUN87~ FUN89	FUN87~ FUN89		
Counter	16-bit up Counter	Retentive	C0~C47 (48)	C0~C31 (32)	
		Non-retentive	C48~C95 (48)	C32~C63 (32)	
	32-bit up Counter	Retentive	C200~C215 (16)	C200~C207 (8)	
		Non-retentive	C216~C231 (16)	C208~C215 (8)	
	Up/Down Counter	Retentive / Non-retentive (16-bit)	FUN7	FUN7	
		Retentive / Non-retentive (32-bit)	FUN7D	FUN7D	
High-speed counter 1 or 2 HHSC*5 + 4 SHSC*6	1-phase 1 input (P or U or D)	HSC0 & HSC1 (2 points, 10K Hz each) + HSC4~7 (total < 5K Hz)			
	1-phase 2 input (U/D or P/R)	HSC0 (1 point, 10K Hz) + HSC4~7 (total < 5K Hz)			
	2-phase 2 input (A/B)	HSC0 (1 point, 5K Hz) + HSC4~7 (total < 5K Hz)			
Register	Retentive	R0~R2999 (3000) D0~D4095 (4096)	R0~R127 (128)		
	Non-retentive	R3000~R3839 (840)	R128~R511 (384)		
	Special use	R3840~R4167 (328) R3968~R4167 (Retentive)	R3840~R4167 (328) R4030~R4057 (Retentive) R4088~R4166 (Retentive)		
	Index register (Retentive)	V · Z (2), P0~P9 (10)	V · Z (2)		
	Read only register	R5000~R8071 (3072)	R5000~R5255 (256)		
Interrupt		X0~X3 (4 points)			
High Speed Pulse Output (HSPSO0, HSPSO1)		Y0~Y3 (4 points, 10K Hz each), after Y4 is low speed (limited in software)			
Serial Communication Port (Port 0 ~ Port 2)		Built-in Port 0, left side is expandable port 1 and port 2 *2 Built-in Port 0 (RS232) + Port 2 (RS485) *3	Built-in Port 0, is not expandable		
Program and data backup battery		Yes	No (program and data backup are within system FLASH)		

*1 . Input (X) + Output (Y) total maximum point is 64 (including the points on main unit)

*2 . Analog expansion module will occupy Port 1. When using analog expansion module, communication can only expand Port 2 one port.

*3 . (△ : 25 module, please refer to page 10), left side is not expandable.

*4 . B1/B1z series does not support run time editing function and also not support Y0~Y255 of Latch Coil –(L); that is, Latch Coil is non-retention.

*5 . HHSC means Hardware High-Speed Counter

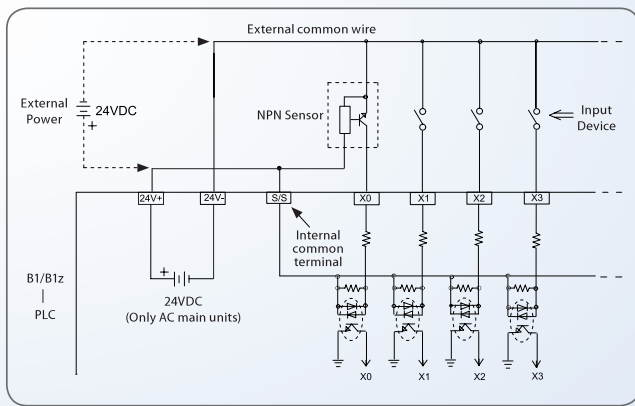
*6 . SHSC means Software High-Speed Counter

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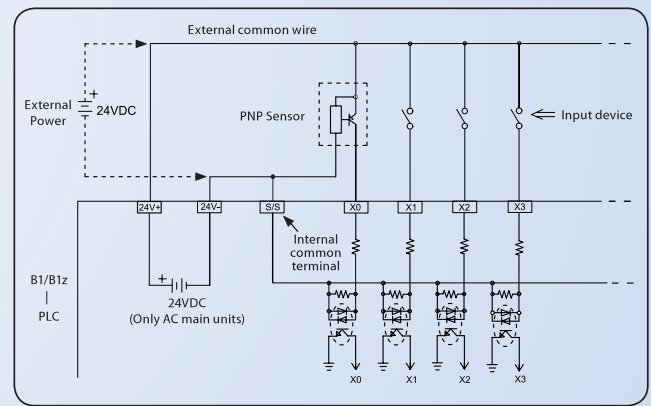
Digital Input (DI) specifications

Specification	Item	24VDC single-end input		Note
		Medium speed(X0~X3)	Low speed (After X4)	
Maximum input frequency *		10KHz	50Hz	*: Limited in hardware frequency and half of maximum frequency while A/B phase input
Input signal voltage		24VDC ± 10%		
Threshold current	ON	> 4mA	> 2.3mA	
	OFF	< 1.5mA	< 0.9mA	
Maximum input current		7mA	4.2mA	
Input indication		Displayed by LED: Light when "ON", dark when "OFF"		DHF: Digital Hardware Filter AHF: Analog Hardware Filter
Isolation method		Photocouple isolation		
SINK/SOURCE wiring		Via variation of internal common terminal S/S and external common wiring		
Noise filtering methods		DHF (0mS ~ 15mS) + AHF (4.7μS)	AHF (4.7mS)	

Wiring of 24VDC single-end SINK input



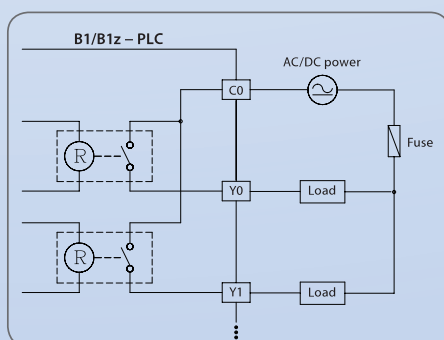
Wiring of 24VDC single-end SOURCE input



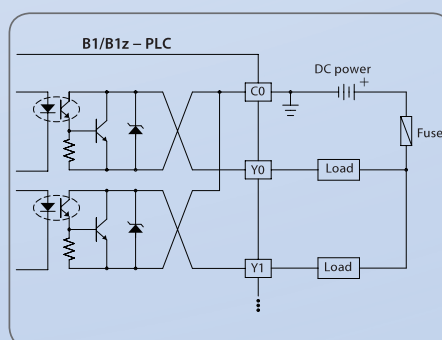
Digital Output (DO) specifications

Specification	Item	Single-end relay output	Single-end transistor output	Note
		Maximum output frequency*	—	
Working voltage		< 250VAC, 30VDC	5 ~ 30 VDC	
Maximum load current	Resistive	2A/single, 4 A/common	0.5A	
	Inductive	80VA		
Maximum voltage drop (@ maximum load)		0.06V (initial)	2.2V	
Minimum load		2mA/DC power	—	
Leakage current		—	< 0.1mA / 30VDC	
Maximum output delay time	ON → OFF	10mS	15μS	
	OFF → ON		30μS	
Output status indication		Displayed by LED: Light when "ON", dark when "OFF"		
Over current protection		N/A		
Isolation type		Electromagnetic isolation	Photocouple isolation	
SINK/SOURCE output type		Bilateral device, can be arbitrarily set to SINK/SOURCE output	Choose SINK/SOURCE by models and non-exchangeable	

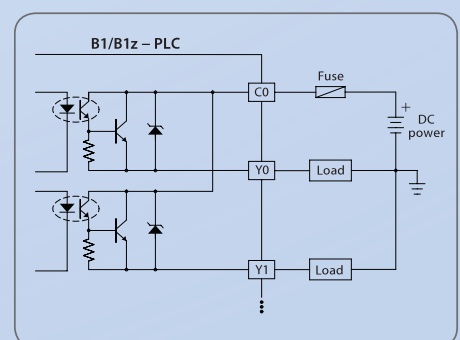
Wiring of relay single-end output



Wiring of transistor single-end SINK output



Wiring of transistor single-end SOURCE output



Model Specifications



B1z main units

Spec.			Model								
			B1z-10MR	B1z-10M(T/J)	B1z-14MR	B1z-14M(T/J)	B1z-20MR	B1z-20M(T/J)	B1z-24MR	B1z-24M(T/J)	
Digital input	24VDC	Medium speed 10KHz	4 points								
		Low speed	2 points		4 points		8 points		10 points		
Digital output	Relay	AC/DC(2A)	4 points	—	6 points	—	8 points	—	10 points	—	
		Transistor (5~30 VDC)	Medium speed 10KHz (0.5A)	—	4 points	—	4 points	—	4 points	—	4 points
			Low speed (0.5A)	—	—	—	2 points	—	4 points	—	6 points
Comm. port	Built-in		1 port (Port0, USB or RS232)								
	Expandable		N/A								
Calendar			—								
Built-in power supply			ZPOW14(AC power) or N/A (DC power)								
Wiring mechanism			5 mm European fixed terminal block								
Dimension			Standard (Figure 1), Slim (Figure 2)*				Standard (Figure 3), Slim (Figure 4)*				

* AC power supply of main unit has no slim shell.



B1 main units

Spec.			Model								
			B1-10MR	B1-10M(T/J)	B1-14MR	B1-14M(T/J)	B1-20MR	B1-20M(T/J)	B1-24MR	B1-24M(T/J)	
Digital input	24VDC	Medium speed 10KHz	4 points								
		Low speed	2 points		4 points		8 points		10 points		
Digital output	Relay	AC/DC(2A)	4 points	—	6 points	—	8 points	—	10 points	—	
		Transistor (5~30 VDC)	Medium speed 10KHz (0.5A)	—	4 points	—	4 points	—	4 points	—	4 points
			Low speed (0.5A)	—	—	—	2 points	—	4 points	—	6 points
Comm. port	Built-in		1 port (Port0, USB or RS232)								
	Expandable		2 ports (Port1 ~ 2, RS485 or RS232)								
Calendar			Optional								
Built-in power supply			ZPOW14(AC power) or N/A (DC power)								
Wiring mechanism			5 mm European fixed terminal block								
Dimension			Standard (Figure 1), Slim (Figure 2)*				Standard (Figure 3), Slim (Figure 4)*				

* AC power supply of main unit has no slim shell.

Right Side Digital I/O Expansion Modules



Spec.			Model						
			B1-8X	B1-8YR	B1-8Y(T/J)	B1-8XYR	B1-8XY(T/J)	B1-16X	B1-16YR
Digital input	24VDC	Low speed	8 points	—	—	4 points	4 points	16 points	—
Digital output	Relay	AC/DC(2A)	—	8 points	—	4 points	—	—	16 points
	Transistor (5 ~ 30VDC)	Low speed (0.5A)	—	—	8 points	—	4 points	—	—
Wiring mechanism			5 mm European fixed terminal block						
Dimension			Standard (Figure 5), Slim (Figure 6)					Standard (Figure 1), Slim (Figure 2)	

Right Side Digital I/O Expansion Modules



Spec.			Model					
			B1-16Y(T/J)	Spec.	B1-16XYR	B1-16XY(T/J)	B1-24XYR	B1-24XY(T/J)
Digital input	24VDC	Low speed	—		8 points	8 points	14 points	14 points
Digital output	Relay	AC/DC(2A)	—		8 points	—	10 points	—
	Transistor (5 ~ 30VDC)	Low speed (0.5A)	16 points		—	8 points	—	10 points
Wiring mechanism			5 mm European fixed terminal block					
Dimension			Standard (Figure 1), Slim (Figure 2)			Standard (Figure3), Slim (Figure 4)		

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Left Side Expansion Modules



Spec.	Model	B1-L2DA	B1-L4AD	B1-L2A1D
Features		2 channels, 12-bit analog output module (0~10V or 0~20mA)	4 channels, 12-bit analog input module (0~10V or 0~20mA)	2 channels, 12-bit analog input + 1 channel, 12-bit analog output combo analog module (0~10V or 0~20mA)
Wiring mechanism		3.81 mm European detachable terminal block		
Dimension		Standard (Figure 8)		

Left Side Communication Expansion Modules



Spec.	Model	B1-CM2	B1-CM22	B1-CM5	B1-CM55	B1-CM25
Features		1 RS232 port with TX, RX indicators	2 RS232 ports with TX, RX indicators	1 RS485 port with TX, RX indicators	2 RS485 ports with TX, RX indicators	1 RS232 port (Port 1) + 1 RS485 port (Port 2) with TX & RX indicators
Wiring mechanism		D-SuB female		3.5mm Screwless terminal block		D-SuB female 3.5mm Screwless terminal block
Dimension		Standard (Figure 7)				

Memory pack



Spec.	Model	FBs-PACK
Memory		1M bits FLASH ROM
Memory capacity		20K* words program + 20K* words data
Write protection		DIP switch ON/OFF protection

*Capacity is limited for B1/B1z

PWMDA



Spec.	Model	PWMDA
Output range		0~10V
Output value		0~1000
Resolution		10mV(10V/1000)
Output impedance		1KΩ
Min. load(≥10V)		5.2KΩ
D/A conversion time		<50mS

Handheld programming panel



Spec.	Model	FP-08
Max. consumption power		5V/100mA
Keyboard		48 silicon rubber keys
Display		Two rows 16-character, dot matrix LCD display, with LED backlight
Communication port		RS232 serial communication port

Data Access Panel



Spec.	Model	FBs-DAP-B/BR	FBs-DAP-C/CR
Display		Two rows 16-character, dot matrix LCD display, with LED backlighting	
Key pads		20 (membrane)	
Max. consumption power		24V, 48mA	5V, 120mA
Communication Interface	Electric	RS485	RS232
	Mechanism	5-pin European detachable terminal block	D-sub 9 pins male connector
	Number of linked station	Max. 16 stations	1
General features		Timer, counter, register, relay, access of contact in PLC	
Special features		Alarm, information display, user definable special quick keys	
Card access feature		Available only in -BR/-CR models, with maximum distance of 6 ~ 12 cm	

RFID card



Spec.	Model	CARD-H
Operated frequency		13.56MHz
Memory		64-bit with Cyclic Redundancy Check (CRC) on data
Working temperature		-25°C ~ 50°C (ISO7810)
Power source		Powered by RF
Receivable distance		6~12cm
Writable times		at least 10000 times
Dimension(mm)		86 X 54 X 0.76
Weight		5g

Dimensions

Figure 1 Standard

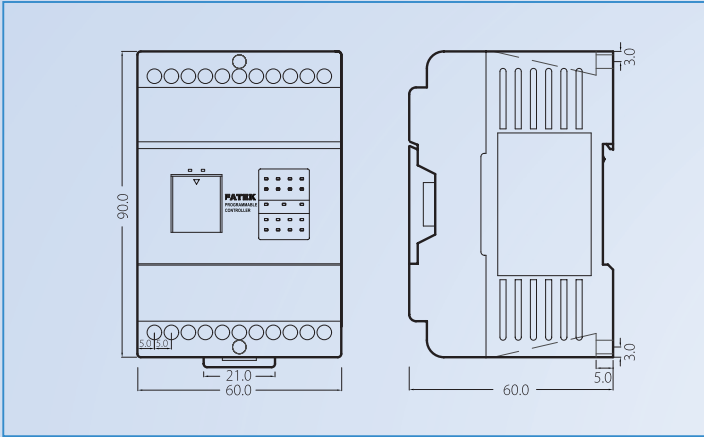


Figure 2 Slim

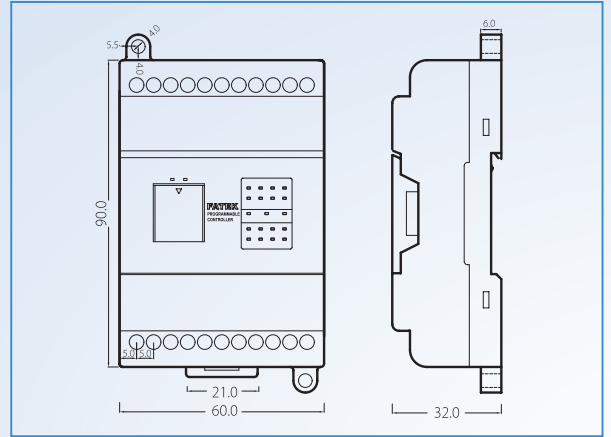


Figure 3 Standard

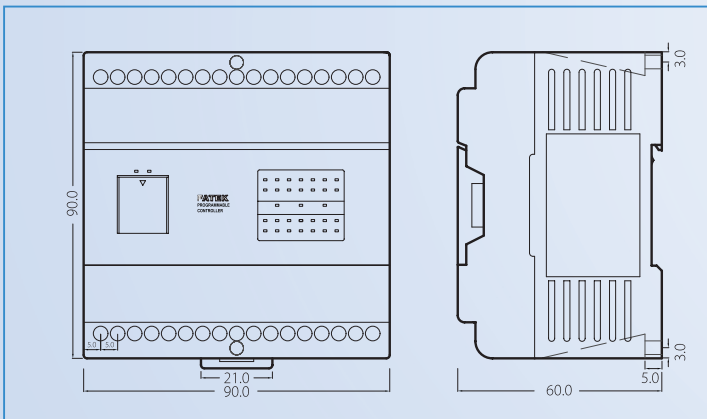


Figure 4 Slim

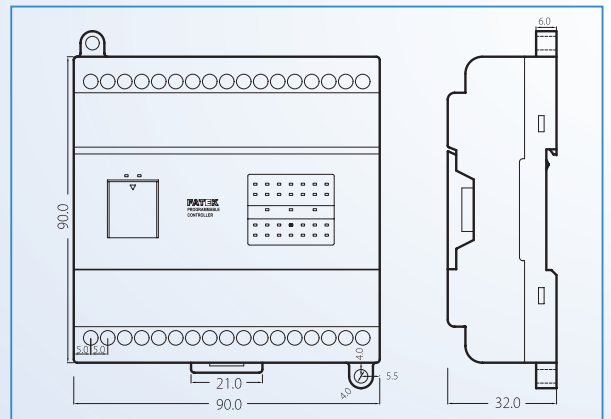


Figure 5 Standard

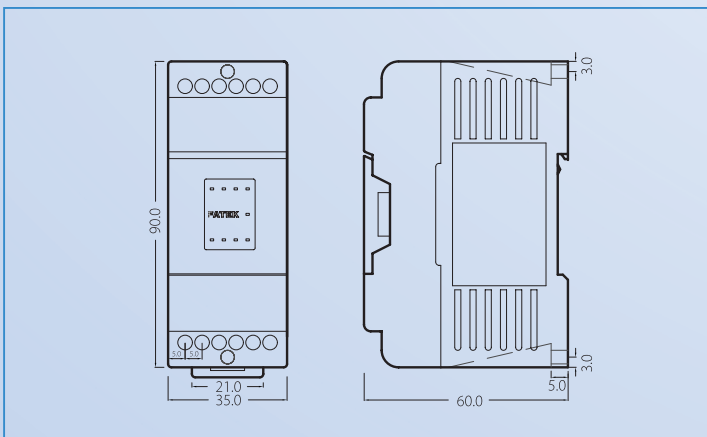


Figure 6 Slim

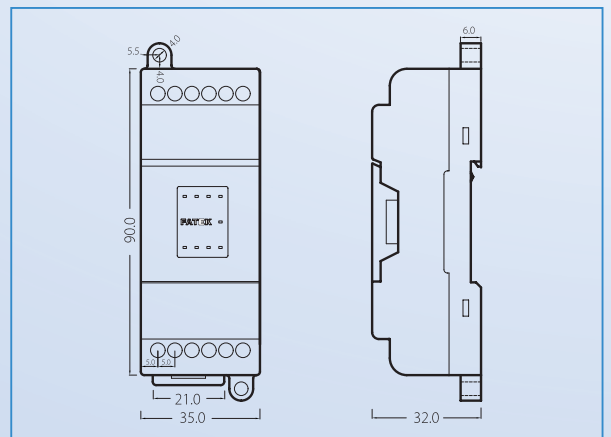


Figure 7 Standard

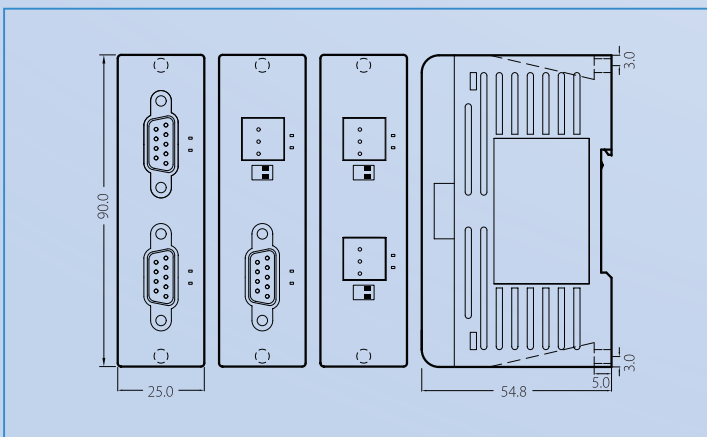
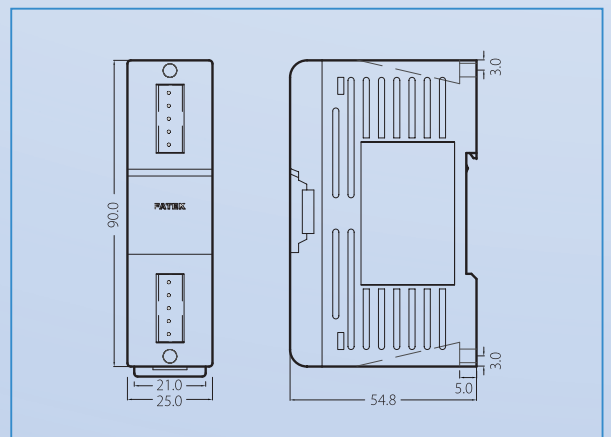


Figure 8 Slim



B1/B1z PLC Model List

Item Name	Model	Specifications	
B1z main units	B1z-10M ◇△-◎☆	6 points 24VDC digital input (4 points 10KHz), 4 points relay output or transistor output (4 points 10KHz), built-in 1 communication port, left/right side is not expandable	
	B1z-14M ◇△-◎☆	8 points 24VDC digital input (4 points 10KHz), 6 points relay output or transistor output (4 points 10 KHz), built-in 1 communication port, left/right side is not expandable	
	B1z-20M ◇△-◎☆	12 points 24VDC digital input (4 points 10KHz), 8 points relay output or transistor output (4 points 10KHz), built-in 1 communication port, left/right side is not expandable	
	B1z-24M ◇△-◎☆	14 points 24VDC digital input (4 points 10KHz), 10 points relay output or transistor output (4 points 10KHz), built-in 1 communication port, left/right side is not expandable	
B1 main units	B1-10M ◇△-◎☆	6 points 24VDC digital input (4 points 10KHz), 4 points relay output or transistor output (4 points 10KHz), built-in 1~2 communication ports, left side is expandable 2~0 modules, right side is expandable up to 64 I/O points	
	B1-14M ◇△-◎☆	8 points 24VDC digital input (4 points 10KHz), 6 points relay output or transistor output (4 points 10KHz), built-in 1~2 communication ports, left side is expandable 2~0 modules, right side is expandable up to 64 I/O points	
	B1-20M ◇△-◎☆	12 points 24VDC digital input (4 points 10KHz), 8 points relay output or transistor output (4 points 10KHz), built-in 1~2 communication ports, left side is expandable 2~0 modules, right side is expandable up to 64 I/O points	
	B1-24M ◇△-◎☆	14 points 24VDC digital input (4 points 10KHz), 10 points relay output or transistor output (4 points 10KHz), built-in 1~2 communication ports, left side is expandable 2~0 modules, right side is expandable up to 64 I/O points	
Right Side Expansion Modules	Digital I/O	B1-8X ☆	8 points 24VDC digital input
		B1-8Y ◇☆	8 points relay or transistor output
		B1-8XY ◇☆	4 points 24VDC digital input, 4 points relay or transistor output
		B1-16X ☆	16 points 24VDC digital input
		B1-16Y ◇☆	16 points relay or transistor output
		B1-16XY ◇☆	8 points 24VDC digital input, 8 points relay or transistor output
		B1-24XY ◇☆	14 points 24VDC digital input, 10 points relay or transistor output
Left Side Expansion Modules	Analog	B1-L2DA	2 channels, 12-bit analog output module(0~10V or 0~20mA)
		B1-L4AD	4 channels, 12-bit analog input module(0~10V or 0~20mA)
		B1-L2A1D	2 channels, 12-bit analog input + 1 channel, 12-bit analog output combo analog module(0~10V or 0~20mA)
	Communication	B1-CM2	1 port RS232 (Port 2) communication module
		B1-CM5	1 port RS485 (Port 2) communication module
		B1-CM22	2 port RS232 communication module
		B1-CM55	2 port RS485 communication module
		B1-CM25	1 port RS232 (Port1) + 1 port RS485(Port2) communication module
Memory Pack programming devices	FBs-PACK	B1/B1z/FBs series of PLC program memory pack with 20K words program, 20K words register, write protection switch	
PWMDA	PWMDA	10-bit single channel pulse width modulation(PWM) 0~10V analog output(AO) module	
Memory Pack programming devices	FP-08	Handheld programmer for B1/B1z/FBs series of PLC	
	Winproladder	FATEK-PLC Winproladder Programming software for Windows	
Data Access Panels / RFID Card	FBs-DAP-B/BR	16 x 2 LCD character display, 20 keys keyboard, 24VDC power supply, RS485 communication interface (suffixed R means wireless card read/write module included)	
	FBs-DAP-C/CR	16 x 2 LCD character display, 20 keys keyboard, 5VDC power supply, RS232 communication interface (suffixed R means wireless card read/write module included)	
	CARD-H	Read / write wireless card (for FBs-DAP-BR/CR)	

- ◇ : R – Relay output T. – Transistor SINK (NPN) output J. – SOURCE (PNP) output
- △ : 2 – built-in 1 RS232 communication port, } left side of B1 main units can expand 1 analog module + 1 communication module (1 port) or 1 communication module (1 or 2 ports)
 U – built-in 1 USB communication port,
 25 – built-in 2 communication ports (RS232 + RS485), only B1 main units provided, and left side is not expandable
- ◎ : AC – 100~240VAC power supply–D24– 24VDC power supply
- ☆ : Blank – Standard case, -S – Slim case (AC power supply has no slim case)

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